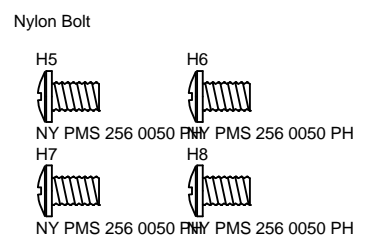
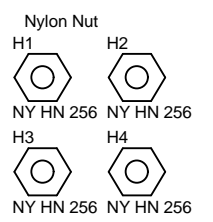


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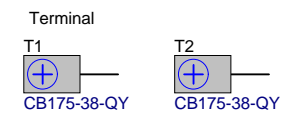
Orderable: DRV425-BUSBAR-EVM	Designed for: Public Release	Mod. Date: 9/8/2017
TID #: N/A	Project Title: DRV425-BUSBAR-EVM	
Number: T1PD205	Rev: B	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: T1PD205BSH.SchDoc	Size: B
Engineer: Javier Contreras	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	





PCB Number: TIPD205  
PCB Rev: B

PCB  
LOGO  
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PCB  
LOGO  
Pb-Free Symbol

PCB  
LOGO  
Texas Instruments

Cable  
H9  
MECH  
2058943-5

Bus Bar  
H10  
MECH  
BB105

H11  
MECH  
EVM\_BusBar\_Inst

ZZ2  
Assembly Note  
EVM\_BusBar\_Inst is a 3D printed part that is manufactured with Nylon12. Stratasys made prototype. Other 3D print manufacure can be used. File types provided (SLDPRT, STEP, STL)

ZZ3  
Assembly Note  
This Assembly Note will show in the PcbDoc and associated outputs

ZZ4  
Assembly Note  
This Assembly Note will show in the PcbDoc and associated outputs

Orderable: <a href="#">DRV425-BUSBAR-EVM</a>	Designed for: <a href="#">Public Release</a>	Mod. Date: 5/26/2017	<p>TEXAS INSTRUMENTS</p> <p>http://www.ti.com</p> <p>© Texas Instruments 2017</p>
TID #: <a href="#">N/A</a>	Project Title: <a href="#">DRV425-BUSBAR-EVM</a>		
Number: <a href="#">TIPD205</a>	Rev: <a href="#">B</a>	Sheet Title:	
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">3</a> of <a href="#">3</a>	
Drawn By: <a href="#">Javier Contreras</a>	File: <a href="#">TIPD205BHW.SchDoc</a>	Size: <a href="#">B</a>	
Engineer: <a href="#">Javier Contreras</a>	Contact: <a href="#">http://www.ti.com/support</a>		

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